Philips Semiconductors-Signetics

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Status	Product Specification
FAST Products	

FAST 74F245
Transceiver

Octal Transceiver (3-State)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F245	4.0ns	70mA

FEATURES

- **Octal bidirectional bus interface**
- **3-state buffer outputs sink 64mA**
- **15 mA source current**
- **Outputs are placed in high impedance state during power-off conditions**

DESCRIPTION

The 74F245 is an octal transceiver featuring non-inverting 3-state bus compatible outputs in both transmit and receive directions. The B port outputs are capable of sinking 64mA and sourcing 15mA, producing very good capacitive drive characteristics.The device features an Output Enable ($\overline{OE}$) input for easy cascading and Transmit/Receive($T/\overline{R}$) input for direction control. The 3-state outputs, B_0-B_7, have been designed to prevent output bus loading if the power is removed from the device.

ORDERING INFORMATION

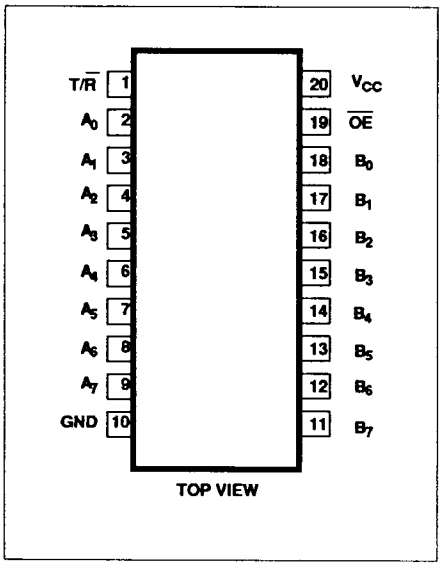
PACKAGES	COMMERCIAL RANGE V_{CC} = 5V±10%; T_A = 0°C to +70°C
20-Pin Plastic DIP	N74F245N
20-Pin Plastic SOL	N74F245D

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

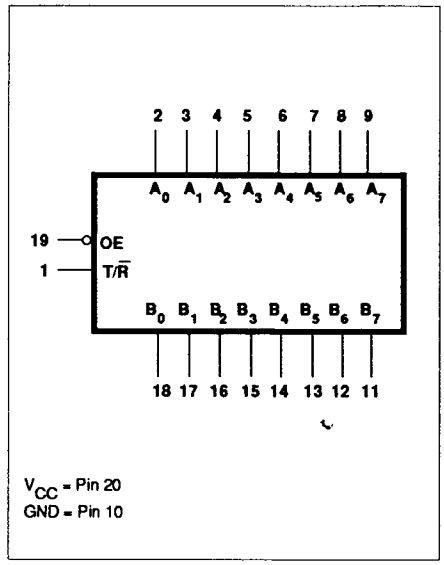
PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A_0- A_7, B_0- B_7	Data inputs	3.5/1.0	70μA/0.6mA
$\overline{OE}$	Output enable input (active Low)	1.0/2.0	20μA/1.2mA
$T/\overline{R}$	Transmit/Receive input	1.0/2.0	20μA/1.2mA
A_0- A_7	A port outputs	150/40	3.0mA/24mA
B_0- B_7	B Port outputs	750/106.7	15mA/64mA

NOTE:
One (1.0) FAST Unit Load is defined as: 20μA in the High state and 0.6mA in the Low state.

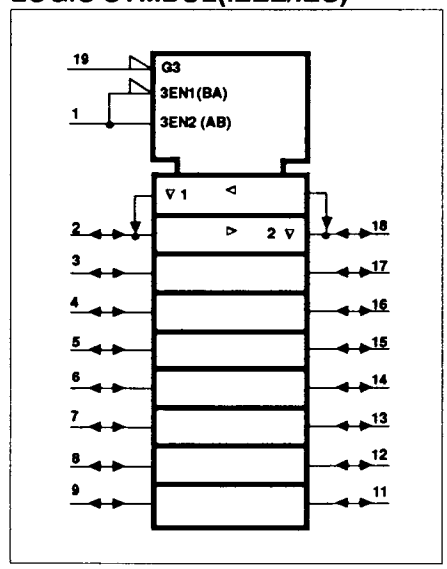
PIN CONFIGURATION



LOGIC SYMBOL



LOGIC SYMBOL(IEEE/IEC)

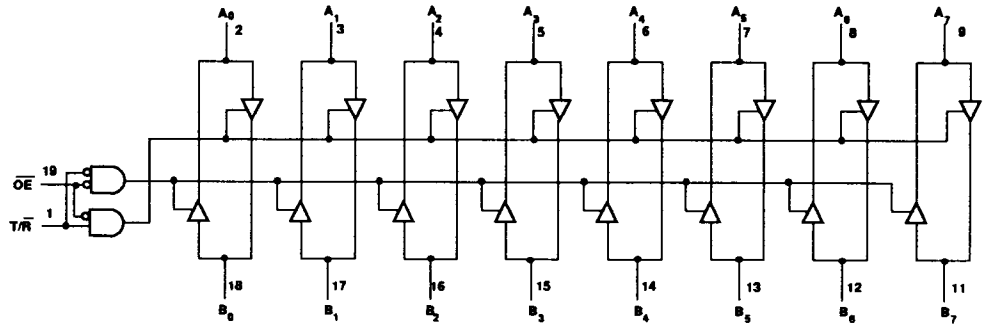


FUNCTION TABLE

INTPUTS		OUTPUTS
$\overline{OE}$	T/$\overline{R}$	
L	L	Bus B data to Bus A
L	H	Bus A data to Bus B
H	X	Z

H=High voltage level
L=Low voltage level
X=Don't care
Z=High impedance "off " state

LOGIC DIAGRAM



V_{CC}=pin 20
GND=pin 10

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		-0.5 to +7.0	V
V_{IN}	Input voltage		-0.5 to +7.0	V
I_{IN}	Input current		-30 to +5	mA
V_{OUT}	Voltage applied to output in High output state		-0.5 to +5.5	V
I_{OUT}	Current applied to output in Low output state	A_0-A_7	48	mA
		B_0-B_7	128	mA
T_A	Operating free-air temperature range		0 to +70	°C
T_{STG}	Storage temperature		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			Min	Nom	Max	
V_{CC}	Supply voltage		4.5	5.0	5.5	V
V_{IH}	High-level input voltage		2.0			V
V_{IL}	Low-level input voltage				0.8	V
I_{IK}	Input clamp current				-18	mA
I_{OH}	High-level output current	A_0-A_7			-3	mA
		B_0-B_7			-15	mA
I_{OL}	Low-level output current	A_0-A_7			24	mA
		B_0-B_7			64	mA
T_A	Operating free-air temperature range		0		70	°C

DC ELECTRICAL CHARACTERISTICS (Over recommended operating free-air temperature range unless otherwise noted.)

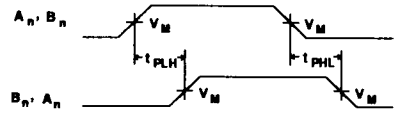
SYMBOL	PARAMETER		TEST CONDITIONS[1]			LIMITS			UNIT
						Min	Typ[2]	Max	
V_{OH}	High-level output voltage	A_0-A_7, B_0-B_7	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OH}=-3mA	±10%V_{CC}	2.4			V
					±5%V_{CC}	2.7	3.4		V
		B_0-B_7		I_{OH}=-15mA	±10%V_{CC}	2.0			V
					±5%V_{CC}	2.0			V
V_{OL}	Low-level output voltage	A_0-A_7	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OL}=20mA	±10%V_{CC}		0.30	0.50	V
				I_{OL}=24mA	±5%V_{CC}		0.35	0.50	V
		B_0-B_7		I_{OL}=MAX	±10%V_{CC}			0.55	V
					±5%V_{CC}		0.42	0.55	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = I_{IK}				-0.73	-1.2	V
I_I	Input current at maximum input voltage	$\overline{OE}$, T/$\overline{R}$	V_{CC} = 5.5V, V_I = 7.0V					100	µA
		A_0-A_7, B_0-B_7	V_{CC} = 5.5V, V_I = 5.5V					1	mA
I_{IH}	High-level input current	$\overline{OE}$, T/$\overline{R}$ only	V_{CC} = MAX, V_I = 2.7V					20	µA
I_{IL}	Low-level input current	$\overline{OE}$, T/$\overline{R}$ only	V_{CC} = MAX, V_I = 0.5V					-1.2	mA
I_{IH}+I_{OZH}	Off-state output current High-level voltage applied		V_{CC} = MAX, V_O= 2.7V					70	µA
I_{IL}+I_{OZL}	Off-state output current Low-level voltage applied		V_{CC} = MAX, V_O= 0.5V					-600	µA
I_{OS}	Short-circuit output current[3]	A_0-A_7	V_{CC} = MAX			-60		-150	mA
		B_0-B_7				-100		-225	mA
I_{CC}	Supply current (total)	I_{CCH}	V_{CC} = MAX				60	87	mA
		I_{CCL}					70	100	mA
		I_{CCZ}					75	110	mA

NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_A = 25°C.
3. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter test, I_{OS} tests should be performed last.

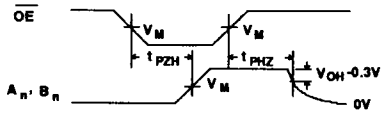
AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS					UNIT
			T_A = +25°C, V_{CC} = 5V, C_L = 50pF, R_L = 500Ω			T_A = 0°C to +70°C, V_{CC} = 5V ±10%, C_L = 50pF, R_L = 500Ω		
			Min	Typ	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation delay A_n to B_n, B_n to A_n	Waveform 1	2.5 2.5	3.5 4.0	6.0 6.0	2.5 2.5	7.0 7.0	ns
t_{PZH} t_{PZL}	Output Enable time to High or Low level	Waveform 2 Waveform 3	2.0 3.5	4.5 5.5	7.0 8.0	2.0 3.5	8.0 9.0	ns
t_{PHZ} t_{PLZ}	Output Disable time from High or Low level	Waveform 2 Waveform 3	2.5 1.0	5.0 3.5	6.5 6.0	2.0 1.0	7.5 7.0	ns

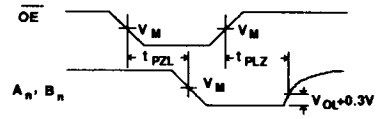
AC WAVEFORMS



Waveform 1. Propagation Delay For Non-Inverting Output



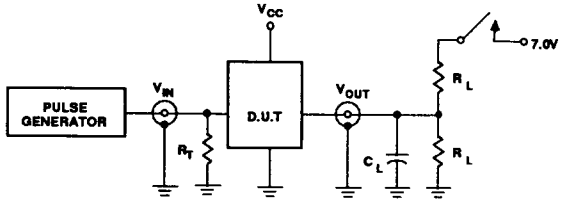
Waveform 2. 3-State Output Enable Time To High Level And Output Disable Time From High Level



Waveform 3. 3-State Output Enable Time To Low Level And Output Disable Time From Low Level

NOTE: For all waveforms, V_M = 1.5V.

TEST CIRCUIT AND WAVEFORMS



Test Circuit For 3-State Outputs

SWITCH POSITION

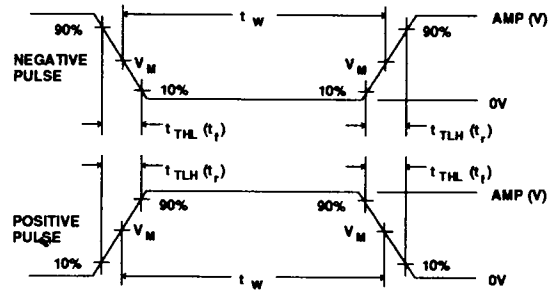
TEST	SWITCH
t_{PLZ}	closed
t_{PZL}	closed
All other	open

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.



V_M = 1.5V

Input Pulse Definition

FAMILY	INPUT PULSE REQUIREMENTS				
	Amplitude	Rep. Rate	t_W	t_{TLH}	t_{THL}
74F	3.0V	1MHz	500ns	2.5ns	2.5ns

VI. COMMERCIAL PRODUCT SPECIAL PROCESSING T-90-20

SUPR II LEVEL B

Signetics Upgraded Product Reliability (SUPR) program is designed to provide customers whose systems require an infant mortality level less than that of our non-burned-in products (which is typically below 1000 PPM).

DEVICE AVAILABILITY

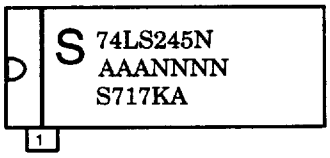
Products available for Level B processing are identified in the Price Book with a "B" suffix to the basic part number.

SUPR II LEVEL B PRICING ADDERS

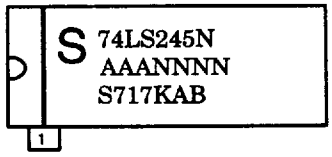
PRODUCT FAMILY	SUGGESTED RESALE ADDERS 1–99	100–999	OVER 1000
LIN	.14	.14	.11
LOG (TTL)			
(SSI)	.12	.10	.08
(MSI)	.16	.14	.11
(OCT)	.16	.14	.11
(CTM)	.16	.14	.11
LOG (ECL)			
(SSI)	.25	.23	.20
(MSI)	.25	.23	.20
LOG (LSI) (RAM) MIC (8X)	Consult Factory for Pricing		
PLD	Consult Factory for Pricing		
MCG	Consult Factory for Pricing		
DAT MIC	Not Available		

MARKING FORMAT EXAMPLES

Standard (no Burn-In) Products (Dual-in-line)



SUPR II (Burned-In) Products (Dual-in-line)



NOTE: The "B" in the 7th position on the 3rd line, when present, is the SUPR II Burn-In indicator.

TAPE AND REEL PACKAGING

SPECIFICATIONS

Tape and Reel specifications conform to Electronic Industries Association (EIA) Proposed Specification #EIA-481-A using 13 inch reels. Current incremental quantities reflect the quantities per reel. As more customers are able to handle a larger quantity per reel, this quantity will be increased.

DEVICE AVAILABILITY

Products available in tape and reel packaging are identified in the Price Book with a "T" suffix to the basic part number and are only offered as a product for sale by the reel. Return of product is limited to full reels with unbroken quality seals.

TAPE AND REEL PRICING ADDERS

PRODUCT FAMILY	SUGGESTED RESALE ADDER
MCG	.07
LIN	.07
LOG	.07
DAT MIC	PACKAGE A28 = .20 A44 = .25 A52 = .30 A68 = .40 A84 = .45 D24 = .17

VII. PACKING QUANTITY INFORMATION

T-90-20

CERAMIC DUAL IN-LINE (CERDIP)

PACKAGE CODE	PIN COUNT	QUANTITIES	
		DEVICES PER TUBE	DEVICES PER BOX
F/FE, BPA, PA	8-pin (300-mil)	48	1920
F, BCA, CA	14-pin (300-mil)	25	1000
F, BEA, EA	16-pin (300-mil)	25	1000
F, BVA, MVA	18-pin (300-mil)	21	840
F/FA, BRA, RA	20-pin (300-mil)	20	800
F, BWA, WA	22-pin (400-mil)	17	544
F/FA/F6, BJA, JA	24-pin (600-mil)	15	360
F/FA/F3/F24, BLA, LA	24-pin (300-mil)	15	600
F, BXA, XA	24-pin (400-mil)	15	480
F/FA/F28, BXA, XA	28-pin (600-mil)	13	312
FA	32-pin (600-mil)	11	264
F/FA/F40, BQA, MQA, QA	40-pin (600-mil)	9	216

CERPAC

PACKAGE CODE	PIN COUNT	QUANTITIES
		DEVICES PER TUBE
BDA/DA/W	14-pin	145
BFA/FA/W	16-pin	145
BXA/BYA/W	18-pin	100
BSA/SA/W/WB	20-pin	100
BKA/KA/W	24-pin	120
BYA/YA/W	28-pin	50

CERQUAD

PACKAGE CODE	PIN COUNT	QUANTITIES	
		DEVICES PER TRAY	DEVICES PER BOX
KA/K44	44-pin	6	6
KA/K68	68-pin	4	4
KA	84-pin	42	210

LEADLESS CHIP CARRIER

PACKAGE CODE	PIN COUNT	QUANTITIES
		DEVICES PER TUBE
B2A/2A/GA	20-pin	55
B3A/3A/GA/GC1	28-pin	43
YA/YA/GC2	32-pin	35
BUA/MXA/MUA/UA/XA/GA/GC	44-pin	27
BZA/BUA/UA/ZA/GA/GC	68-pin	19

QUANTITIES SHOWN IN GRAY REQUIRE PURCHASE TO BE MADE IN EXACT MULTIPLES OF THAT QUANTITY.

VII. PACKING QUANTITY INFORMATION

T-90-20

PLASTIC DUAL IN-LINE

PACKAGE CODE	PIN COUNT	QUANTITIES	
		DEVICES PER TUBE	DEVICES PER BOX
N/N8	8-pin (300-mil)	50	2000
N/N14/N16	14- 16-pin (300-mil)	25	1000
N	18-pin (300-mil)	20	800
N/N20	20-pin (300-mil)	18	720
N	22-pin (400-mil)	17	544
N/N6	24-pin (600-mil)	15	360
N/N3/N24	24-pin (300-mil)	15	600
N/N24	24-pin (400-mil)	15	480
N/N28	28-pin (600-mil)	13	312
N/N3	28-pin (300-mil)	13	520
N	32-pin (600-mil)	11	264
N/N40	40-pin (600-mil)	9	216
NB (Shrink)	42-pin (600-mil)	12	288
N/N48	48-pin (600-mil)	7	168
N	50-pin (900-mil)	7	112
N/N64	64-pin (900-mil)	5	80

PLASTIC LEADED CHIP CARRIER (PLCC)

PACKAGE CODE	PIN COUNT	QUANTITIES		
		DEVICES PER TUBE	DEVICES PER BOX	DEVICES PER REEL
A	20-pin	46	3680	1000
A/A28	28-pin	37	2368	750
A	32-pin	31	2232	750
A/A44	44-pin	26	1248	500
A/A52	52-pin	23	1012	500
A/A68	68-pin	18	648	250
A/A84	84-pin	15	420	250

QUANTITIES SHOWN IN GRAY REQUIRE PURCHASE TO BE MADE IN EXACT MULTIPLES OF THAT QUANTITY.

VII. PACKING QUANTITY INFORMATION

T-90-20

PLASTIC SMALL OUTLINE (SO)

PACKAGE CODE	PIN COUNT	QUANTITIES		
		DEVICES PER TUBE	DEVICES PER BOX	DEVICES PER REEL
D/D8	8-pin (150-mil)	100	10000	2500
D	8-pin (300-mil)	64	2560	1000 – 13" 700 – 7"
D/D14	14-pin (150-mil)	57	5700	2500
D	16-pin (150-mil)	50	5000	2500
D	16-pin (300-mil)	48	1920	1000
DK(SSOP)	20-pin (170-mil)	75	6750	2500
D	20-pin (300-mil)	38	1520	1000
D/D24	24-pin (300-mil)	32	1280	1000
D	28-pin (300-mil)	27	1080	1000
D	40-pin (VSO-40)	31	1240	1000 – 13" 300 – 7"
D	56-pin (VSO-56)	22	616	1000

QUAD FLAT PACK*

PACKAGE CODE	PIN COUNT	QUANTITIES	
		DEVICES PER TRAY	DEVICES PER BOX
B/B44	44-pin	50	500
B/B44	44-pin	96	480
B	52-pin	119	595
B	80-pin	66	330
B	100-pin	50	250
B	120-pin	24	120
B	120-pin (Philips source)	30	150

* Quad Flat Pack parts require dry pack handling according to EIA Standard - 583.
These parts are identified in part list section with DRY PACK in the Cross Ref Part No field.

QUANTITIES SHOWN IN GRAY REQUIRE PURCHASE TO BE MADE IN EXACT MULTIPLES OF THAT QUANTITY.

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